

#### **Features**

- · S<sub>21</sub> = 31.4 dB @ 2110 MHz = 30.6 dB @ 2170 MHz
- · NF of 2.0 dB over Frequency
- · Unconditionally Stable
- · Single 5V Supply
- · High OIP3 @ Low Current

#### Description

The plerow™ APM-Series is an internally matched amplifier mini-module for such application band in SMD package with the output P1dB of 29 dBm. It is compactly designed for low current consumption and high OIP3. Integrating all the components for biasing and matching within the module enhances production yield and throughput as well. It passes through the stringent DC, RF, and reliability tests. Not sample test but 100% quality control test is made before packing.







2-stage Single Type

# **Specifications (in Production)**

Typ. @ T = 25°C,  $V_s$  = 5 V, Freq. = 2140 MHz,  $Z_{o.sys}$  = 50 ohm

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Unit	Specifications			
Offic	Min	Тур	Max	
MHz	2110		2170	
dB	30	31		
dB		± 0.4	± 0.5	
dB		2.0	2.1	
dBm	44	47		
dB			-18 / -10	
dBm	28	29		
μsec		-	1	
mA		460	500	
V		5		
Ω	50			
dBm	C.W 23 ~ 25 (before fail)			
mm	Surface Mount Type, 13Wx13Lx3.8H			
	dB dB dBm dB dBm  μsec mA V Ω dBm	Min  MHz  2110  dB  30  dB  dB  dBm  44  dB  dBm  28  μsec  mA  V  Ω  dBm  C.W	Unit         Min         Typ           MHz         2110         31           dB         30         31           dB         ± 0.4         4           dB         2.0         dBm           dBm         44         47           dB         28         29           μsec         -         -           mA         460         V           5         50         50           dBm         C.W 23 ~ 25 (before	

#### **More Information**

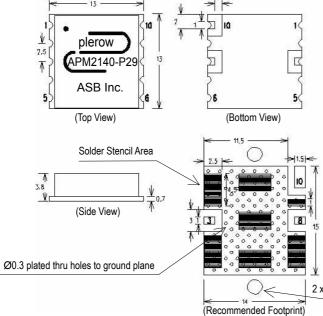
Website: www.asb.co.kr E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223 Fax: (82) 42-528-7222

ASB Inc., 4th Fl. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Operating temperature is -40°C to +85°C.

#### Outline Drawing (Unit: mm)



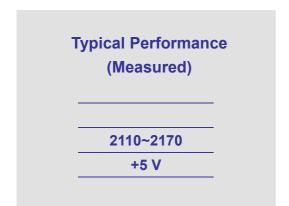
Pin Number	Function		
3	RF In		
8	RF Out		
10	+Vcc		
Others	Ground		

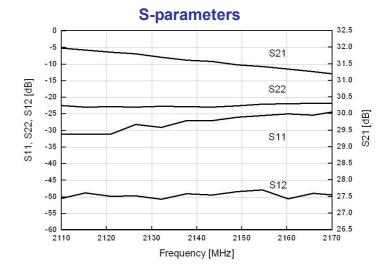
Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

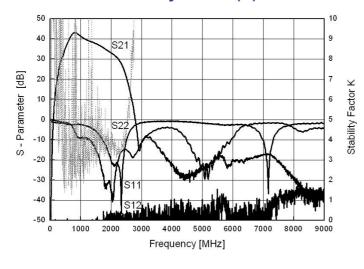
<sup>1)</sup> OIP3 is measured with two tones at an output power of 15 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V<sub>S</sub>.



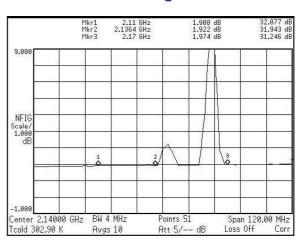




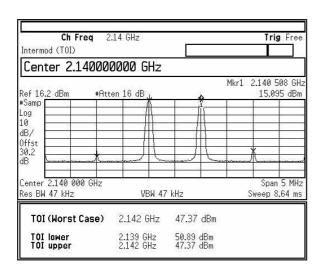
### **Stability Factor (K)**



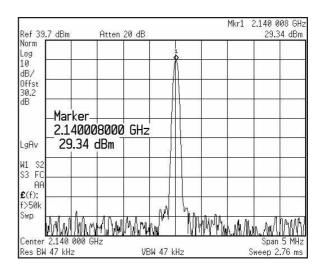
### **Noise Figure**



#### OIP3



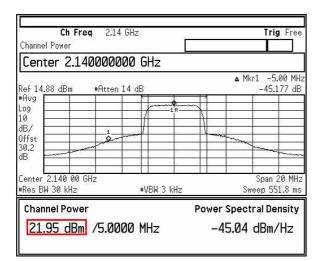
#### P1dB

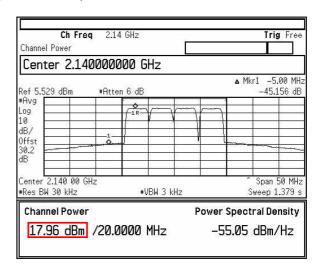




#### **Output Channel Power**

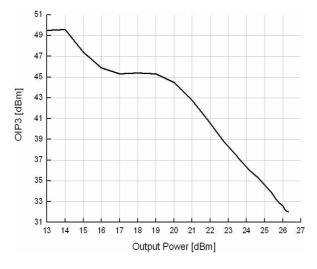
(@ ACLR=-45dBc, +/-5MHz Offset)



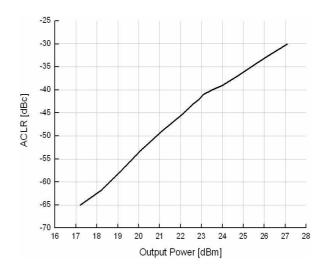


#### **OIP3 vs Output Power**

#### (@ 1MHz offset, 1-tone power)



### **ACLR vs Channel Power**



\*\* Test Source : Agilent E4433B (3GPP W-CDMA Test Model-1 64DPCH)



# **RF Performance with Voltage Change**

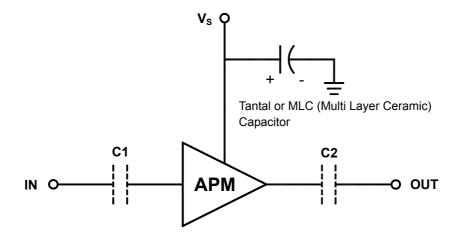
Item Voltage	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
4.5	-30.77	-14.64	31.92	0.53	1.742	28.99	41.99	319
4.6	-29.95	-14.62	32.03	0.53	1.770	29.25	42.78	347
4.7	-29.42	-14.62	32.12	0.53	1.820	29.29	43.80	374
4.8	-28.81	-14.58	32.19	0.53	1.852	29.42	45.15	401
4.9	-28.31	-14.57	32.25	0.53	1.908	29.54	46.93	426
5.0	-28.04	-14.63	32.30	0.53	1.942	29.65	47.53	451
5.1	-28.65	-16.63	32.33	0.53	2.000	29.73	47.16	475
5.2	-27.37	-14.69	32.35	0.53	2.060	29.81	46.91	498
5.3	-27.19	-14.78	32.35	0.53	2.103	29.86	45.83	520
5.4	-27.12	-14.82	32.33	0.51	2.166	29.91	45.34	539
5.5	-27.04	-14.96	32.30	0.51	2.210	29.96	44.93	558

# **RF Performance with Operating Temperature**

Item Temp.	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
- 40°C	-28.53	-13.24	33.34	0.50	1.583	30.10	43.40	418
- 20°C	-28.39	-13.67	33.03	0.49	1.727	30.00	44.27	433
0°C	-28.49	-13.83	32.81	0.49	1.822	29.85	45.34	442
25°C	-28.15	-14.37	32.33	0.48	1.951	29.44	47.51	440
40°C	-27.68	-14.67	32.07	0.45	2.063	29.48	47.05	440
60°C	-27.39	-14.92	31.75	0.43	2.252	29.32	46.71	435
80°C	-26.58	-15.29	31.30	0.40	2.396	29.10	45.04	430
100°C	-25.64	-15.97	30.88	0.36	2.616	28.86	43.51	425

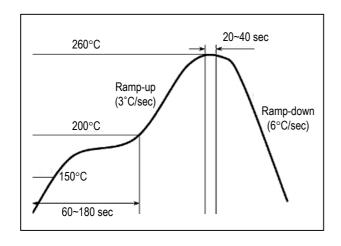


#### **Application Circuit**

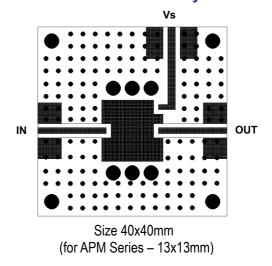


- The tantal or MLC (Multi Layer Ceramic) capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status. The capacitor should be placed as close as possible to V<sub>s</sub> pin and be connected directly to the ground plane for the best electrical performance.
- 2) DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the APM module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

#### **Recommended Soldering Reflow Process**

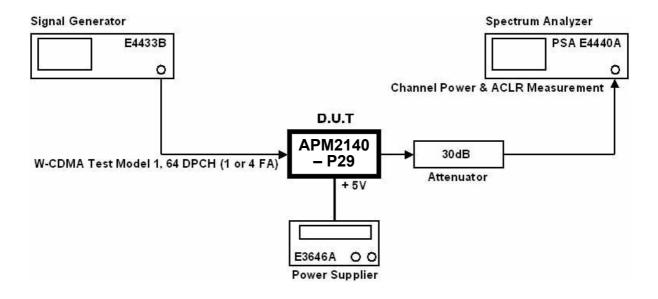


#### **Evaluation Board Layout**

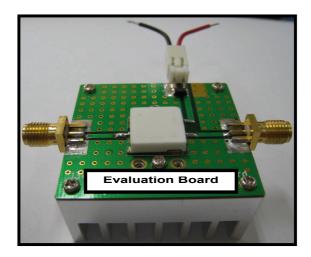




# **Channel Power vs. ACLR Test Configuration**



#### **Evaluation Board attached with Heat Sink**



<sup>\*</sup> In order to prevent damage of D.U.T (APM-Series) from heating, you must to use a properly sized heat sink for testing a module.